



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: WHONCHEE LEE *ET AL.*

APPLICATION NO.: 10/665,219

FILED: SEPTEMBER 17, 2003

FOR: **METHODS AND APPARATUS FOR  
REMOVING CONDUCTIVE MATERIAL  
FROM A MICROELECTRONIC  
SUBSTRATE**

EXAMINER: DUNG V. NGUYEN

ART UNIT: 3723

CONF. No: 6284

**Amendment in Response to Restriction Requirement**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated May 11, 2004, please amend the application as reflected in the following listing of claims.